N-Channel Power MOSFET

60V, 35A, 22mΩ

FEATURES

- Low $R_{DS(ON)}$ to minimize conductive losses
- Low gate charge for fast power switching
- 100% UIS and R_g tested.
- 175°C Operating Junction Temperature
- Compliant to RoHS directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21

KEY PERFORMANCE PARAMETERS

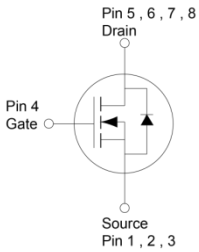
PARAMETER		VALUE	UNIT
V_{DS}		60	V
$R_{DS(on)}$ (max)	V_{GS} = 10V	22	mΩ
Q_g		23	nC

APPLICATIONS

- BLDC Motor Control
- Battery Power Management
- DC-DC converter
- Secondary Synchronous Rectification

Pb-Free RoHS COMPLIANT HALOGEN FREE

PDFN56



Note: MSL 1 (Moisture Sensitivity Level) per J-STD-020

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C unless otherwise noted)

PARAMETER		SYMBOL	LIMIT	UNIT
Drain-Source Voltage		V_{DS}	60	V
Gate-Source Voltage		V_{GS}	±20	V
Continuous Drain Current (Note 1)	T_C = 25°C	I_D	35	A
	T_A = 25°C		8	
Pulsed Drain Current		I_{DM}	140	A
Single Pulse Avalanche Current (Note 2)		I_{AS}	15	A
Single Pulse Avalanche Energy (Note 2)		E_{AS}	33.8	mJ
Total Power Dissipation	T_C = 25°C	P_D	68	W
	T_C = 125°C		23	
Total Power Dissipation	T_A = 25°C	P_D	3.1	W
	T_A = 125°C		1	
Operating Junction and Storage Temperature Range		T_J, T_{STG}	- 55 to +175	°C

THERMAL PERFORMANCE

PARAMETER	SYMBOL	LIMIT	UNIT
Junction to Case Thermal Resistance	$R_{\Theta JC}$	2.2	°C/W
Junction to Ambient Thermal Resistance	$R_{\Theta JA}$	48	°C/W

Thermal Performance Note: $R_{\Theta JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistances. The case-thermal reference is defined at the solder mounting surface of the drain pins. $R_{\Theta JA}$ is guaranteed by design while $R_{\Theta CA}$ is determined by the user's board design. The $R_{\Theta JA}$ limit presented here is based on mounting on a 1 in^2 pad of 2 oz copper.

ELECTRICAL SPECIFICATIONS (T_A = 25°C unless otherwise noted)						
PARAMETER	**CONDITIONS**	**SYMBOL**	**MIN**	**TYP**	**MAX**	**UNIT**
Static						
Drain-Source Breakdown Voltage	V_{GS} = 0V, I_D = 250μA	BV_{DSS}	60	--	--	V
Gate Threshold Voltage	V_{GS} = V_{DS}, I_D = 250μA	$V_{GS(TH)}$	2	3.3	4	V
Gate-Source Leakage Current	V_{GS} = ±20V, V_{DS} = 0V	I_{GSS}	--	--	±100	nA
Drain-Source Leakage Current	V_{GS} = 0V, V_{DS} = 60V	I_{DSS}	--	--	1	μA
	V_{GS} = 0V, V_{DS} = 60V T_J = 125°C		--	--	100	
Drain-Source On-State Resistance **(Note 3)**	V_{GS} = 10V, I_D = 8A	$R_{DS(on)}$	--	19	22	mΩ
Forward Transconductance **(Note 3)**	V_{DS} = 10V, I_D = 8A	g_{fs}	--	35	--	S
Dynamic **(Note 4)**						
Total Gate Charge	V_{GS} = 10V, V_{DS} = 30V, I_D = 8A	Q_g	--	23	-	nC
Gate-Source Charge		Q_{gs}	--	6.5	--	
Gate-Drain Charge		Q_{gd}	--	5.4	--	
Input Capacitance	V_{GS} = 0V, V_{DS} = 30V f = 1.0MHz	C_{iss}	--	1454	--	pF
Output Capacitance		C_{oss}	--	90	--	
Reverse Transfer Capacitance		C_{rss}	--	24	--	
Gate Resistance	f = 1.0MHz	R_g	0.6	2	4	Ω
Switching **(Note 4)**						
Turn-On Delay Time	V_{GS} = 10V, V_{DS} = 30V, I_D = 8A, R_G = 2Ω	$t_{d(on)}$	--	3	--	ns
Turn-On Rise Time		t_r	--	19	--	
Turn-Off Delay Time		$t_{d(off)}$	--	10	--	
Turn-Off Fall Time		t_f	--	18	--	
Source-Drain Diode						
Forward Voltage **(Note 3)**	V_{GS} = 0V, I_S = 8A	V_{SD}	--	--	1.2	V
Reverse Recovery Time	I_S = 8A, dI/dt = 100A/μs	t_{rr}	--	16	--	ns
Reverse Recovery Charge		Q_{rr}	--	11	--	nC

Notes:

1. Silicon limited current only.
2. L = 0.3mH, V_{GS} = 10V, V_{DD} = 30V, R_G = 25Ω, I_{AS} = 15A, Starting T_J = 25°C
3. Pulse test: Pulse Width ≤ 300μs, duty cycle ≤ 2%.
4. Switching time is essentially independent of operating temperature.

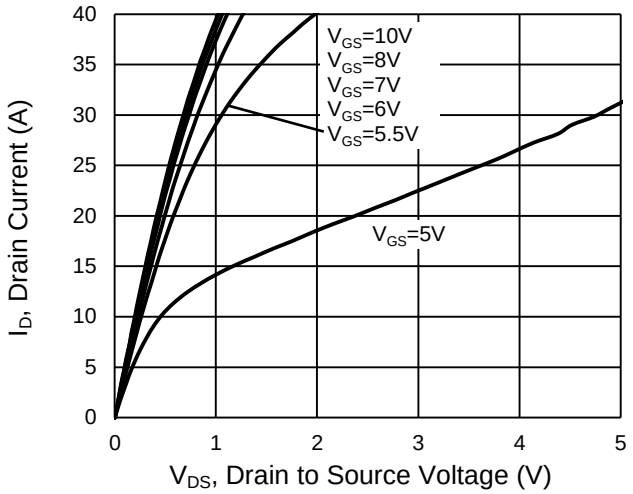
ORDERING INFORMATION

PART NO.	PACKAGE	PACKING
TSM220NB06CR RLG	PDFN56	2,500pcs / 13” Reel

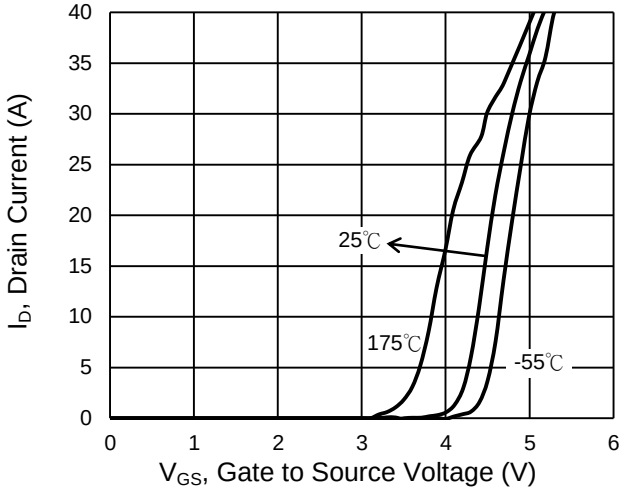
CHARACTERISTICS CURVES

(T_A = 25°C unless otherwise noted)

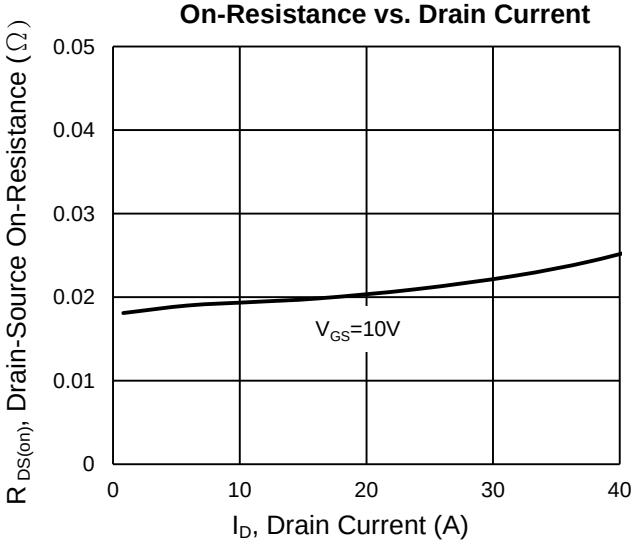
Output Characteristics



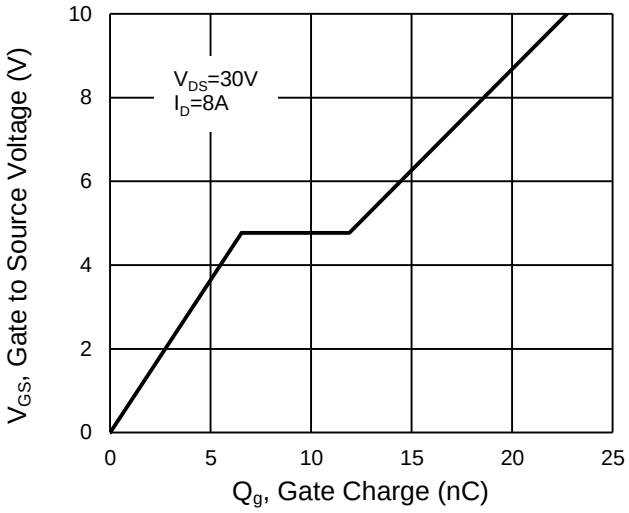
Transfer Characteristics



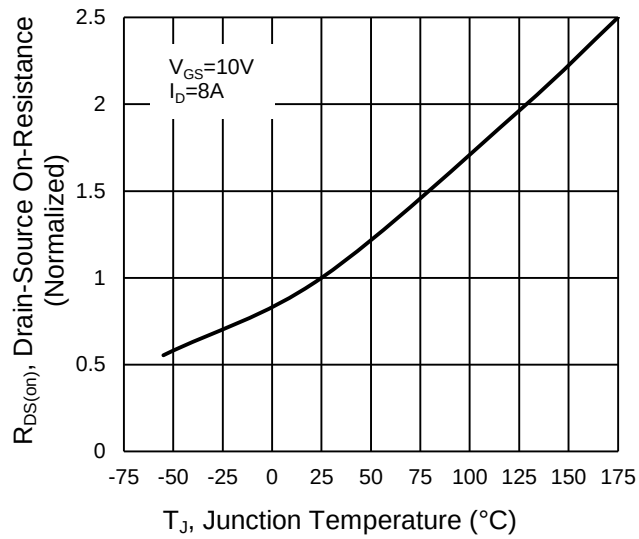
On-Resistance vs. Drain Current



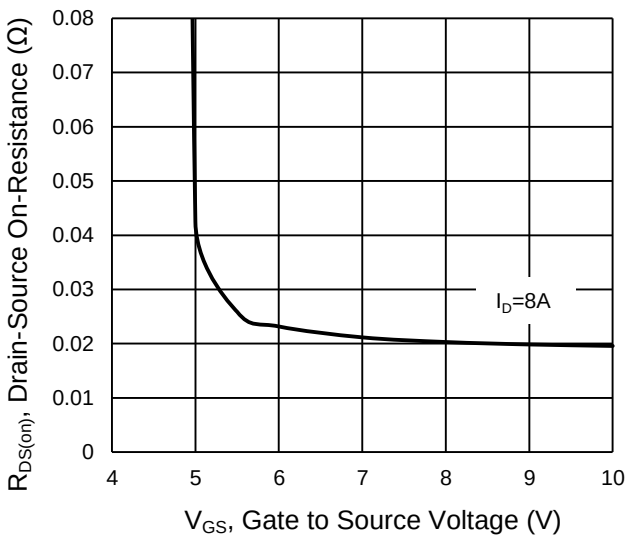
Gate-Source Voltage vs. Gate Charge



On-Resistance vs. Junction Temperature



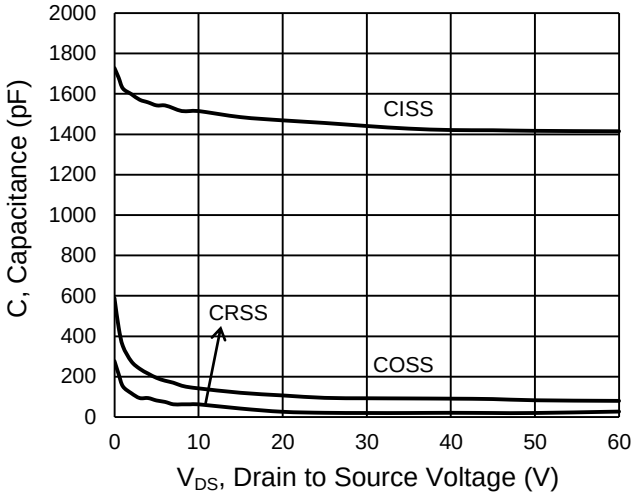
On-Resistance vs. Gate-Source Voltage



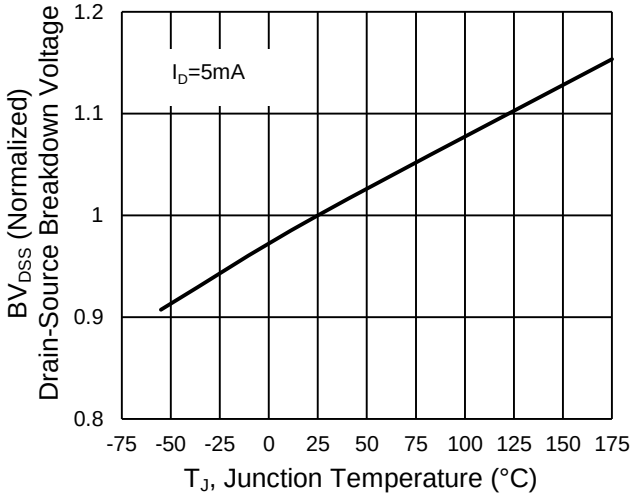
CHARACTERISTICS CURVES

(T_A = 25°C unless otherwise noted)

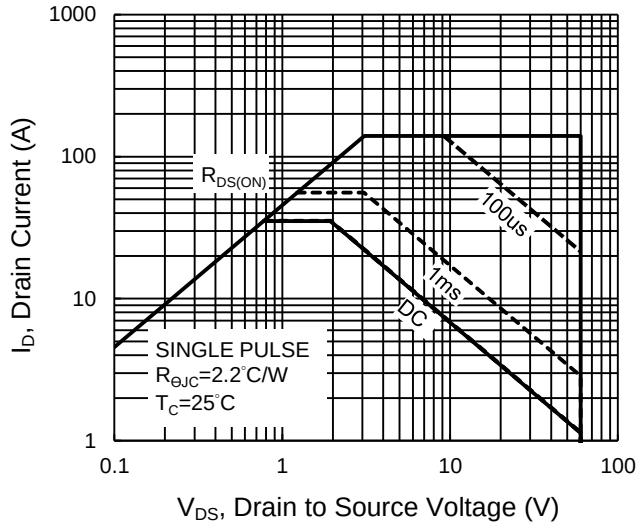
Capacitance vs. Drain-Source Voltage



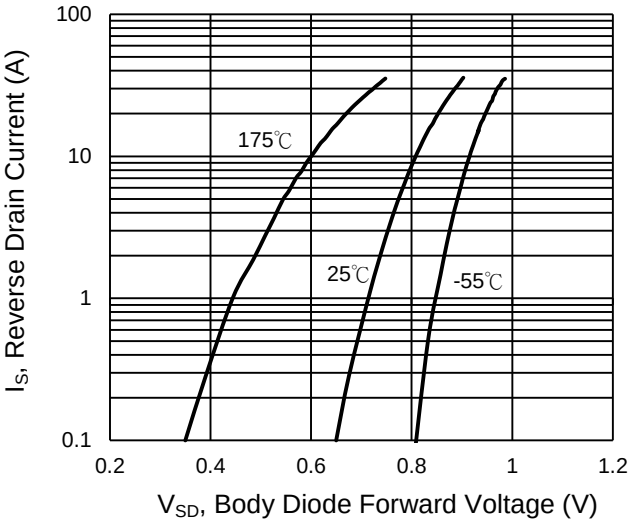
BV_{DSS} vs. Junction Temperature



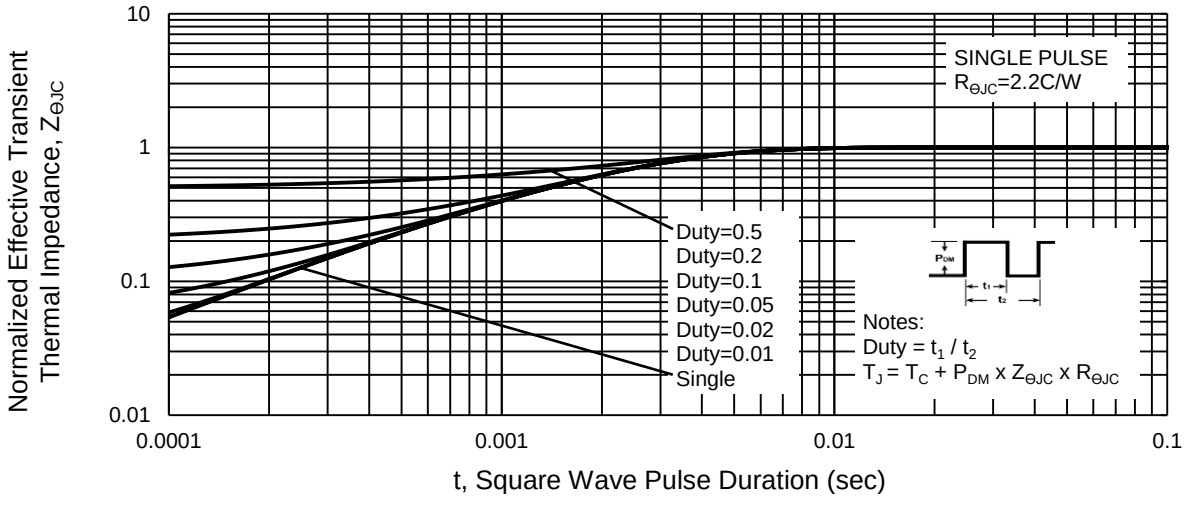
Maximum Safe Operating Area, Junction-to-Case



Source-Drain Diode Forward Current vs. Voltage

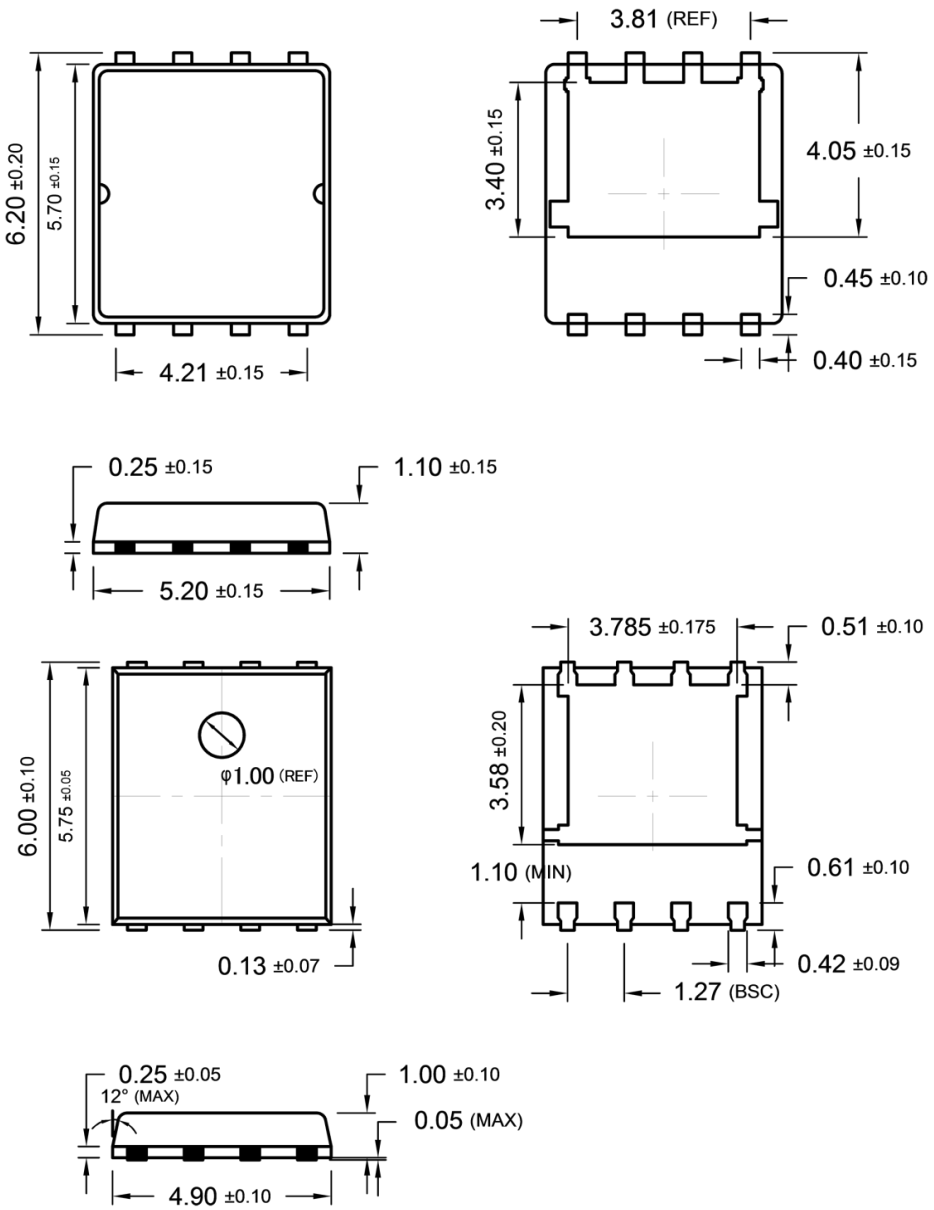


Normalized Thermal Transient Impedance, Junction-to-Case

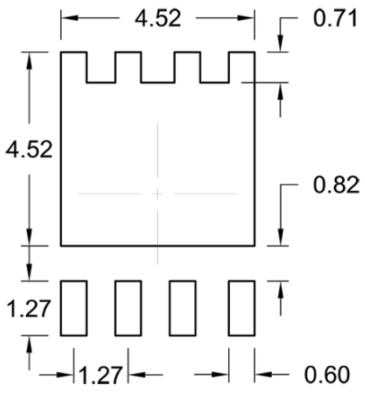


PACKAGE OUTLINE DIMENSIONS (Unit: Millimeters)

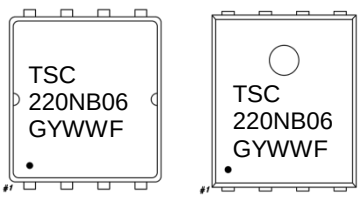
PDFN56



SUGGESTED PAD LAYOUT (Unit: Millimeters)



MARKING DIAGRAM



G = Halogen Free
Y = Year Code
WW = Week Code (01~52)
F = Factory Code

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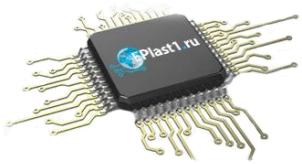
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

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